

LTC1385

3.3V Low Power EIA/TIA-562 Transceiver

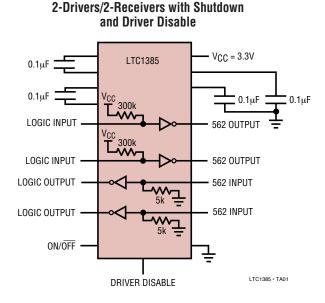
FEATURES

- Operates from a Single 3.3V Supply
- Low Supply Current: I_{CC} = 200µA
- $I_{CC} = 35 \mu A$ in Driver Disable Mode
- I_{CC} = 0.2µA in Shutdown Mode
- ESD Protection Over ±10kV
- Uses Small Capacitors: 0.1µF
- Operates to 120kBaud
- Output Overvoltage Does Not Force Current Back into Supplies
- EIA/TIA-562 I/O Lines Can Be Forced to ±25V Without Damage
- Pin Compatible with LT1180A
- Available in 20-Lead SSOP,18-Lead PDIP and 18-Lead SO Packages

APPLICATIONS

- Notebook Computers
- Palmtop Computers

TYPICAL APPLICATION



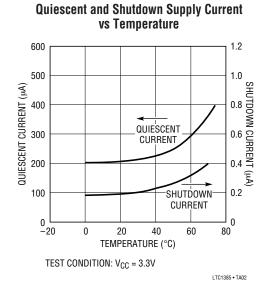
DESCRIPTION

The LTC[®]1385 is an ultra-low power, 2-driver/2-receiver EIA/TIA-562 transceiver which operates from a single 3.3V supply. The charge pump requires only four space-saving 0.1μ F capacitors.

The transceiver operates in one of three modes: Normal, Driver Disable or Shutdown. In the Normal mode, I_{CC} is only 200µA in the unloaded condition. In the Driver Disable mode, the charge pump is turned off, the driver outputs are forced into three-state, both receivers are kept active, and I_{CC} drops to 35µA. In the Shutdown mode, everything is turned off and I_{CC} drops to 0.2µA.

The LTC1385 is fully compliant with all data rate and overvoltage EIA/TIA-562 specifications. The transceiver can operate up to 120kbaud with a 1000pF, $3k\Omega$ load. Both driver outputs and receiver inputs can be forced to $\pm 25V$ without damage, and can survive multiple $\pm 10kV$ ESD strikes.

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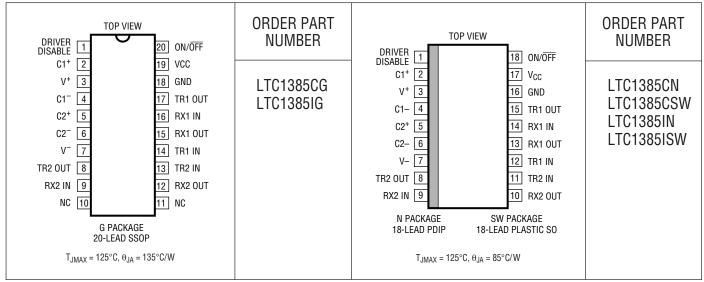


ABSOLUTE MAXIMUM RATINGS

Supply Voltage (V _{CC}) 5V
Input Voltage
Driver $-0.3V$ to V _{CC} + 0.3V
Receiver25V to 25V
Digital Input – 0.3V to V _{CC} + 0.3V
Output Voltage
Driver 25V to 25V
Receiver $-0.3V$ to V_{CC} + 0.3V

Short-Circuit Duration
V ⁺
V ⁻
Driver Output Indefinite
Receiver Output Indefinite
Operating Temperature Range
LTC1385C 0°C to 70°C
LTC1385I – 40°C to 85°C
Storage Temperature Range65°C to 150°C
Lead Temperature (Soldering, 10 sec) 300°C

PACKAGE/ORDER INFORMATION



Consult LTC Marketing for parts specified with wider operating temperature ranges.

DC ELECTRICAL CHARACTERISTICS The • denotes specifications which apply over the full operating

temperature range. $V_{CC} = 3.3V$, $C1 = C2 = C3 = C4 = 0.1 \mu F$, $V_{ON/OFF} = V_{CC}$, Driver Disable = V_{CC} , unless noted.

PARAMETER	CONDITIONS			MIN	ТҮР	MAX	UNITS
Any Driver							
Output Voltage Swing	3k to GND	Positive Negative	•	3.7 -3.7	4.5 - 4.5		V V
Logic Input Voltage Level	Input Low Level (V _{OUT} = High) Input High Level (V _{OUT} = Low)		•	2.0	1.4 1.4	0.8	V V
Logic Input Current	$V_{IN} = V_{CC}$ $V_{IN} = 0V$		•		-20	5 -40	μΑ μΑ
Output Short-Circuit Current	V _{OUT} = 0V				±10		mA
Output Leakage Current	Shutdown or Driver Disable or $V_{CC} = 0V$ ($V_{OUT} = \pm 20V$	Note 3,4),	•		±10	±500	μA



1385fb

DC ELECTRICAL CHARACTERISTICS The \bullet denotes specifications which apply over the full operating temperature range. V_{CC} = 3.3V, C1 = C2 = C3 = C4 = 0.1 μ F, V_{ON/OFF} = V_{CC}, Driver Disable = V_{CC}, unless noted.

PARAMETER	CONDITIONS		MIN	ТҮР	MAX	UNITS
Any Receiver						
Input Voltage Thresholds	Input Low Threshold Input High Threshold	•	0.8	1.3 1.7	2.4	V V
Hysteresis		•	0.1	0.4	1.0	V
Input Resistance	$-10V \le V_{IN} \le 10V$		3	5	7	kΩ
Output Voltage	Output Low, $I_{OUT} = -1.6$ mA (V _{CC} = 3.3V) Output High, $I_{OUT} = 160\mu$ A (V _{CC} = 3.3V)	•	3.0	0.2 3.2	0.4	V V
Output Short-Circuit Current	Sinking Current, V _{OUT} = V _{CC} Sourcing Current, V _{OUT} = 0V		-5 2	-20 7		mA mA
Output Leakage Current	Shutdown (Note 4), $0V \le V_{OUT} \le V_{CC}$	•		1	10	μA
Power Supply Generator						
V ⁺ Output Voltage	I _{OUT} = 0mA I _{OUT} = 5mA			5.7 5.5		V V
V ⁻ Output Voltage	$I_{OUT} = 0mA$ $I_{OUT} = -5mA$			-5.3 -5.0		V V
Supply Rise Time	Shutdown or Driver Disable to Turn-On			0.2		ms
Power Supply						
V _{CC} Supply Current	No Load (Note 2), 0°C to 70°C No Load (Note 2), -40°C to 85°C	•		0.2 0.35	0.5 1.0	mA mA
Supply Leakage Current (V_{CC})	Shutdown (Note 4) Driver Disable (Note 3)	•		0.2 35	10 50	μΑ μΑ
Digital Input Threshold Low		•		1.4	0.8	V
Digital Input Threshold High		•	2.0	1.4		V

AC CHARACTERISTICS The \bullet denotes specifications which apply over the full operating temperature range. $V_{CC} = 3.3V$, $C1 = C2 = C3 = C4 = 0.1 \mu F$, unless noted.

PARAMETER	CONDITIONS		MIN	ТҮР	MAX	UNITS
Slew Rate	R _L = 3k, C _L = 51pF			8	30	V/µs
	$R_{L} = 3k, C_{L} = 1000pF$		3	5		V/µs
Driver Propagation Delay	t _{HLD} (Figure 1)	•		2	3.5	μS
(TTL to EIA/TIA-562)	t _{LHD} (Figure 1)	•		2	3.5	μS
Receiver Propagation Delay	t _{HLR} (Figure 2)	•		0.3	0.8	μS
(EIA/TIA-562 to TTL)	t _{LHR} (Figure 2)	•		0.2	0.8	μS

Note 1: Absolute Maximum Ratings are those values beyond which the life of the device may be impaired.

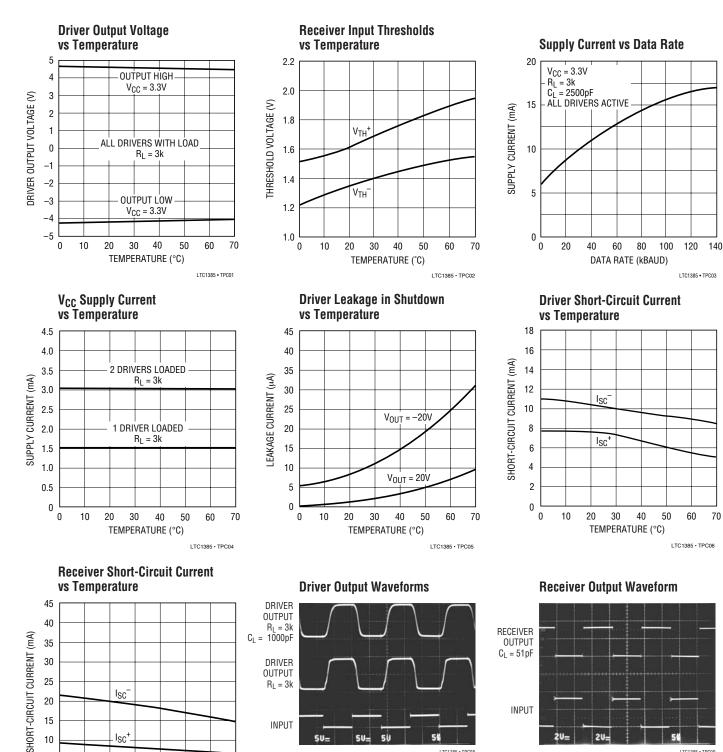
Note 2: Supply current is measured with driver and receiver outputs unloaded.

Note 3: Measurements made in the Driver Disable mode are performed with $V_{DRIVER DISABLE} = GND$ and $V_{ON/\overline{OFF}} = V_{CC}$.

Note 4: Measurements made in the Shutdown mode are performed with $V_{ON/\overline{OFF}} = 0V.$



TYPICAL PERFORMANCE CHARACTERISTICS



LTC1385 • TPC08

INPUT

50:

LTC1385 • TPC09

1385fb



 I_{SC}^+

TEMPERATURE (°C)

LTC1385 • TPC06

PIN FUNCTIONS

 V_{CC} : 3.3V Input Supply Pin. This pin should be decoupled with a 0.1 μF ceramic capacitor.

GND: Ground Pin.

ON/OFF: TTL/CMOS Compatible Shutdown Pin. A logic low puts the device in the Shutdown mode independent of the Driver Disable pin. The supply current drops to 0.2μ A and all driver and receiver outputs are forced into three-state.

DRIVER DISABLE: TTL/CMOS Compatible Input Pin. With the ON/OFF pin held high, a logic low forces the part into the Driver Disable mode with the charge pump turned off and the driver outputs forced into three-state. Both receivers remain active and the supply current drops to 35µA. A logic high forces the part into the Normal mode.

V⁺: Positive Supply Output (EIA/TIA-562 Drivers). $V^+ \cong 2V_{CC} - 1V$. This pin requires an external capacitor $C = 0.1 \mu F$ for charge storage. The capacitor may be tied to ground or V_{CC}. With multiple devices, the V⁺ and V⁻ pins may share a common capacitor. For a large number of devices, increasing the size of the shared common storage capacitors is recommended to reduce ripple.

V⁻: Negative Supply Output (EIA/TIA-562 Drivers). $V^{-} \approx -(2V_{CC} - 1.3V)$. This pin requires an external capacitor C = 0.1 µF for charge storage. **C1⁺, C1⁻, C2⁺, C2⁻:** Commutating Capacitor Inputs. These pins require two external capacitors $C = 0.1 \mu$ F: one from C1⁺ to C1⁻, and another from C2⁺ to C2⁻. To maintain charge pump efficiency, the capacitor's effective series resistance should be less than 2 Ω .

TR IN: EIA/TIA-562 Driver Input Pins. Inputs are TTL/ CMOS compatible. The inputs of unused drivers can be left unconnected since 300k input pull-up resistors to V_{CC} are included on chip. To minimize power consumption, the internal driver pull-up resistors are disconnected from V_{CC} in the Shutdown mode.

TR OUT: Driver Outputs at EIA/TIA-562 Voltage Levels. Outputs are in a high impedance state when in the Shutdown or Driver Disable mode or $V_{CC} = 0V$. The driver outputs are protected against ESD to ±10kV for human body model discharges.

RX IN: Receiver Inputs. These pins can be forced to $\pm 25V$ without damage. The receiver inputs are protected against ESD to $\pm 10kV$ for human body model discharges. Each receiver provides 0.4V of hysteresis for noise immunity.

RX OUT: Receiver Outputs with TTL/CMOS Voltage Levels. Outputs are in a high impedance state when in the Shutdown mode.

SWITCHING TIME WAVEFORMS

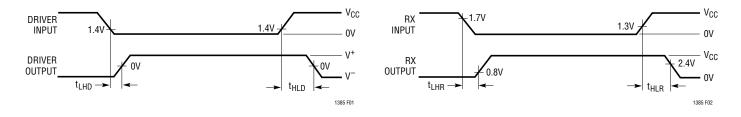


Figure 1. Driver Propagation Delay Timing

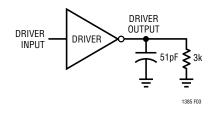
Figure 2. Receiver Propagation Delay Timing



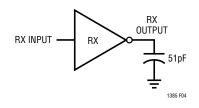
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TEST CIRCUITS

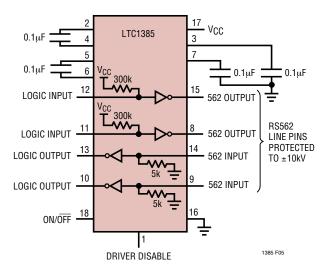
Driver Timing Test Load



Receiver Timing Test Load



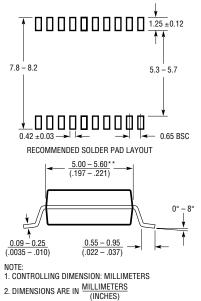


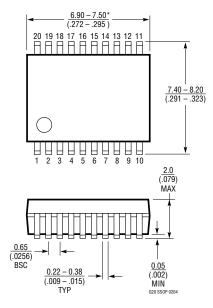




PACKAGE DESCRIPTION

G Package 20-Lead Plastic SSOP (5.3mm) (Reference LTC DWG # 05-08-1640)



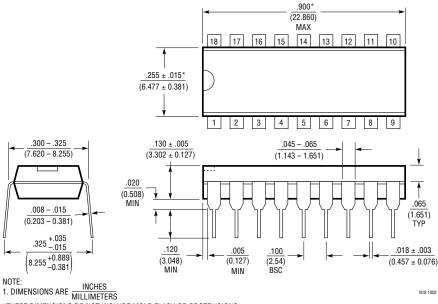


3. DRAWING NOT TO SCALE

- *DIMENSIONS DO NOT INCLUDE MOLD FLASH. MOLD FLASH SHALL NOT EXCEED .152mm (.006") PER SIDE
- **DIMENSIONS DO NOT INCLUDE INTERLEAD FLASH. INTERLEAD FLASH SHALL NOT EXCEED .254mm (.010") PER SIDE

N Package 18-Lead PDIP (Narrow .300 Inch)

(Reference LTC DWG # 05-08-1510)

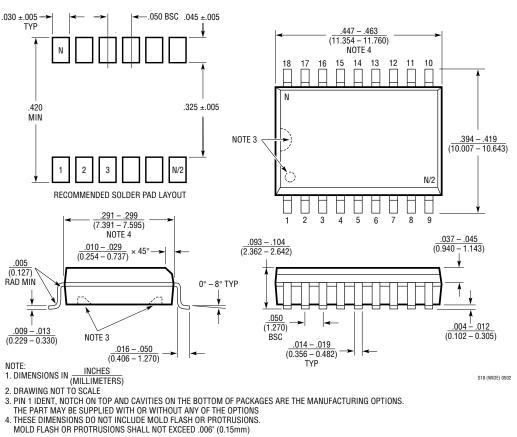


*THESE DIMENSIONS DO NOT INCLUDE MOLD FLASH OR PROTRUSIONS. MOLD FLASH OR PROTRUSIONS SHALL NOT EXCEED .010 INCH (0.254mm)



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PACKAGE DESCRIPTION



SW Package 18-Lead Plastic Small Outline (Wide .300 Inch) (Reference LTC DWG # 05-08-1620)

RELATED PARTS

PART NUMBER	DESCRIPTION	COMMENTS
LT1780/LT1781	5V, 2 Driver, 2 Receiver RS232 Transceivers	±15kV ESD per IEC 1000-4
LTC1327	3.3V, 3 Driver, 5 Receiver RS562 Transceiver	300µA Supply Current, 0.2µA in Shutdown
LTC1348	3.3V to 5V, 3 Driver, 5 Receiver RS232 Transceiver	True RS232 on 3.3V, 5 Receivers Active in Shutdown
LTC1382	5V, 2 Driver, 2 Receiver RS232 Transceiver	200µA Supply Current, 0.2µA in Shutdown
LTC1383	5V, 2 Driver, 2 Receiver RS232 Transceiver	200µA Supply Current, Narrow 16-Pin SO
LTC1384	5V, 2 Driver, 2 Receiver RS232 Transceiver	200µA Supply Current, 2 Receivers Active in Shutdown
LTC1386	3.3V, 2 Driver, 2 Receiver RS562 Transceiver	200µA Supply Current, Narrow 16-Pin SO
LTC1386	3.3V, 2 Driver, 2 Receiver RS562 Transceiver	200µA Supply Current, Narrow 16-Pin SO

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